

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIV)

# TPC8115

Lithium Ion Battery Applications  
 Notebook PC Applications  
 Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance:  $R_{DS(ON)} = 6.5 \text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 40 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = -10 \text{ }\mu\text{A}$  (max) ( $V_{DS} = -20 \text{ V}$ )
- Enhancement mode:  $V_{th} = -0.5 \text{ to } -1.2 \text{ V}$  ( $V_{DS} = -10 \text{ V}$ ,  $I_D = -1\text{mA}$ )

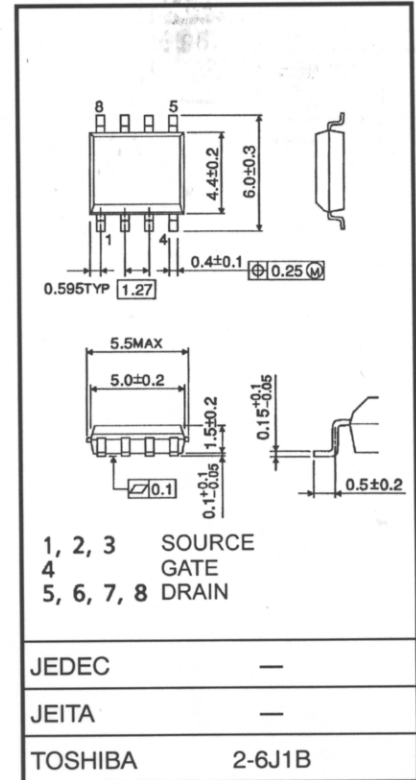
### Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DS}$	-20	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	-20	V
Gate-source voltage		$V_{GSS}$	$\pm 8$	V
Drain current	DC (Note 1)	$I_D$	-10	A
	Pulse (Note 1)	$I_{DP}$	-40	
Drain power dissipation	( $t = 10 \text{ s}$ ) (Note 2a)	$P_D$	1.9	W
Drain power dissipation	( $t = 10 \text{ s}$ ) (Note 2b)	$P_D$	1.0	W
Single pulse avalanche energy	(Note 3)	$E_{AS}$	26	mJ
Avalanche current		$I_{AR}$	-10	A
Repetitive avalanche energy	(Note 2a) (Note 4)	$E_{AR}$	0.19	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55 to 150	$^\circ\text{C}$

Note: For (Note 1), (Note 2), (Note 3) and (Note 4), please refer to the next page.

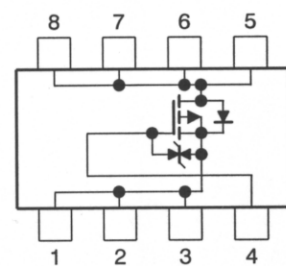
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm



Weight: 0.080 g (typ.)

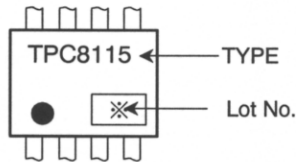
### Circuit Configuration



**Thermal Characteristics**

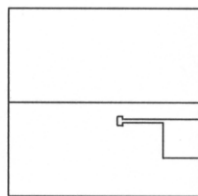
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	$R_{th(ch-a)}$	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	$R_{th(ch-a)}$	125	°C/W

**Marking (Note 5)**



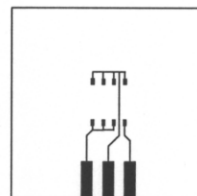
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



FR-4  
25.4 × 25.4 × 0.8  
(unit: mm)

(a)



FR-4  
25.4 × 25.4 × 0.8  
(unit: mm)

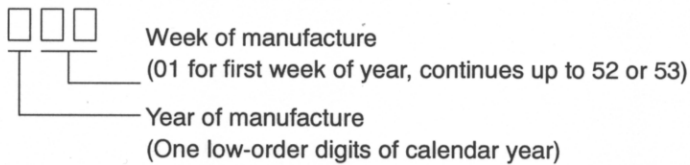
(b)

Note 3:  $V_{DD} = -16V$ ,  $T_{ch} = 25°C$  (initial),  $L = 0.2$  mH,  $R_G = 25 \Omega$ ,  $I_{AR} = -10$  A

Note 4: Repetitive rating; pulse width limited by maximum channel temperature

Note 5: • on lower left of the marking indicates Pin 1.

※ Weekly code: (Three digits)



**Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 8\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-OFF current		$I_{DSS}$	$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}$	—	—	-10	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR) DSS}$	$I_D = -10\text{ mA}, V_{GS} = 0\text{ V}$	-20	—	—	V
		$V_{(BR) DSX}$	$I_D = -10\text{ mA}, V_{GS} = 8\text{ V}$	-10	—	—	
Gate threshold voltage		$V_{th}$	$V_{DS} = -10\text{ V}, I_D = -1\text{ mA}$	-0.5	—	-1.2	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = -1.8\text{ V}, I_D = -5.0\text{ A}$	—	15	30	m $\Omega$
			$V_{GS} = -2.5\text{ V}, I_D = -5.0\text{ A}$	—	9.0	14	
			$V_{GS} = -4.5\text{ V}, I_D = -5.0\text{ A}$	—	6.5	10	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = -10\text{ V}, I_D = -5.0\text{ A}$	20	40	—	S
Input capacitance		$C_{iss}$	$V_{DS} = -10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	9130	—	pF
Reverse transfer capacitance		$C_{rss}$		—	1020	—	
Output capacitance		$C_{oss}$		—	1110	—	
Switching time	Rise time	$t_r$	<p><math>V_{GS} = 0\text{ V}</math> <math>V_{GS} = -5\text{ V}</math> <math>I_D = -5\text{ A}</math> <math>V_{OUT}</math> <math>R_L = 2\ \Omega</math> <math>47\ \Omega</math> <math>V_{DD} = -10\text{ V}</math> Duty <math>\leq 1\%</math>, <math>t_w = 10\ \mu\text{s}</math></p>	—	14	—	ns
	Turn-ON time	$t_{on}$		—	26	—	
	Fall time	$t_f$		—	228	—	
	Turn-OFF time	$t_{off}$		—	666	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} = -16\text{ V}, V_{GS} = -5\text{ V}, I_D = -10\text{ A}$	—	115	—	nC
Gate-source charge 1		$Q_{gs1}$		—	18	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	34	—	

**Source-Drain Ratings and Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	$I_{DRP}$	—	—	—	-40	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = -10\text{ A}, V_{GS} = 0\text{ V}$	—	—	1.2	V

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